

Attachment No. 2

CE-2.9 SUBCOMMITTEE ON SOCKETS

October 4-5, 2004, San Diego, CA

Acting subcommittee Chair Bill Upstone welcomed everyone, and said that the meeting would be conducted following the published agenda.

1. The minutes of the April 19-20, 2004 meeting in Tampa, FL were approved.

2. REAFFIRMED DOCUMENTS

SP-4970: EIA-540DAAA-A: Detail, DIP

It was noted in the minutes of the last meeting that this standard had received insufficient votes and that the standard would be sent out on a second 30-day SP ballot. It was reported that the ballot expired 19 May 2004. Carl will check with EIA on the results of the 30-day SP ballot, and what ballot action was received.

SP-4971: EIA-700A0AB: 68-pin Memory Card Connector

It was noted in the minutes of the last meeting that this standard had received insufficient votes and that the standard would be sent out on a second 30-day SP ballot. It was reported that the ballot expired 19 May 2004. Carl will check with EIA on the results of the 30-day SP ballot, and what ballot action was received.

3. PINK SHEET BALLOTS

SP-3874: Detail, SODIMM (Tyco is sponsor. New draft needed!)
No report.

SP-4965: Rev. EIA-540B0AE: Detail Land Grid Array (Contech Research is sponsor)
It was suggested in the April 2004 meeting that this document is really a test sequence and should be addressed by CE-2.1. No report.

SP-4973: EIA-540B0AB: Low Pin Count BGA
It was suggested in the April 2004 meeting that this document is really a test sequence and should be addressed by CE-2.1. No report.

SP-4982: EIA-5400000A: Generic
It was moved and approved to send to EIA for a second SP ballot due to insufficient votes at the last ballot. No report.

SP-4983: EIA-540BAAA-A: Detail, Mechanically Actuated PGA (Contech Research is the sponsor)
Awaiting a revised document. No report.

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4. DRAFT DOCUMENTS

SP-5055: Replacement document for EIA-676 Detail, SFF 1.8” (15 mm) Disk Drives
Carl Fritz reported that he formatted a draft for SP-5055 and sent to Harvey Waltersdorf on 11 Jun 2004. Cecelia Yates indicated that she received it, and is in the process of preparing it for SP ballot as of 30 September 2004.

5. FIVE YEAR REVIEW

EIA-540C000: Sectional Relay Sockets (John Bruno of Deutsch is reviewing)
Awaiting response from Deutsch on whether to rescind, reaffirm or revise. No report

EIA-540CA00: Blank, Relay Sockets (John Bruno of Deutsch is reviewing)
Awaiting response from Deutsch on whether to rescind, reaffirm or revise. No report.

EIA-540CAAA: Detail, 10A Relay Socket (John Bruno of Deutsch is reviewing)
Awaiting response from Deutsch on whether to rescind, reaffirm or revise. No report

EIA-540CAAB: Detail, 5A Relay Socket (John Bruno of Deutsch is reviewing)
Awaiting response from Deutsch on whether to rescind, reaffirm or revise. No report.

It was moved and approved to send out the following documents for reaffirmation:

- EIA-700A0AC: Detail, 88-pin DRAM Connector
- EIA-540A000-A: Sectional, Chip Carrier Sockets
- EIA-540AA00: Blank, Leadless Chip Carrier Sockets
- EIA-540AAAA: Detail, Type A Chip Carrier Sockets
- EIA-540AB00: Blank, PQFP
- EIA-540ABAA: Detail, PQFP
- EIA-540AC00: Blank, PCC
- EIA-540ACAA: Detail, PCC
- EIA-540AD00: Blank, Adaptor QFP to PGA
- EIA-540B000: Sectional, PGA
- EIA-540BA00: Blank, PGA
- EIA-540BAAB: Detail, Non-Mechanical PGA
- EIA-540BAAC: Detail, Flex Carrier PGA
- EIA-540D000-A: Sectional, In-Line Packages
- EIA-540DA00: Blank, DIP (Will be sent out for review)
- EIA-540DAAB: Detail, Flex Carrier DIP
- EIA-540EA00: Blank, Round Sockets
- EIA-540EAAA: Detail, Round Sockets
- EIA-540F000: Sectional, Multi-Package Modules

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SP-5058: EIA-720: Detail, SFF 2.5" Disk Drives

It was reported that the specification is out on a SP ballot. The ballot expires on 26 Oct 2004.

SP-5056: EIA-674: Detail, SFF 1.8" Disk Drives

It was reported that the specification was sent out on a SP ballot on 16 August 2004. The ballot expires on 18 Oct 2004.

SP-5057: EIA-675: Detail, SFF 1.3" Disk Drives

It was reported that the specification was rescinded on 2 June 2004.

SP-5059: EIA-677: Detail, SFF Power Connector Pin Dimensions

It was reported that the ballot was issued on 3 June 2004. No report.

6. NEW BUSINESS

There was no new business to report.

All actions taken by the subcommittee were moved and unanimously approved by the EIA CE-2.0 committee. The meeting adjourned at 4:30 PM on 4 October 2004.

Respectively,

Carl Fritz
Recording Secretary

Bill Upstone
Acting Chairman CE-2.9